30V P-CHANNEL ENHANCEMENT MODE MOSFET

SUMMARY

 $V_{(BR)DSS}$ =-30V; $R_{DS(ON)}$ =0.35 Ω ; I_D =-1.1A

DESCRIPTION

This new generation of high density MOSFETs from Zetex utilizes a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, power management applications.

FEATURES

- Low on-resistance
- · Fast switching speed
- Low threshold
- Low gate drive
- SOT23 package

APPLICATIONS

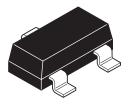
- DC DC converters
- Power management functions
- Disconnect switches
- Motor control

ORDERING INFORMATION

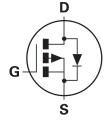
| DEVICE | REEL SIZE (inches) | TAPE WIDTH (mm) | QUANTITY PER REEL |
|-------------|--------------------|--------------------|----------------------|
| ZXM61P03FTA | 7 | 8 embossed | 3,000 |
| ZXM61P03FTC | 13 | 8 embossed | 10,000 |

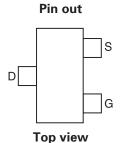
DEVICE MARKING

P03



SOT23







ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | LIMIT | UNIT |
|--|----------------------------------|--------------|-------------|
| Drain-Source Voltage | V _{DSS} | -30 | V |
| Gate- Source Voltage | V _{GS} | ±20 | V |
| Continuous Drain Current $(V_{GS}=-10V; T_A=25^{\circ}C)(b)$ $(V_{GS}=-10V; T_A=70^{\circ}C)(b)$ | I _D | -1.1 -0.9 | А |
| Pulsed Drain Current (c) | I _{DM} | -4.3 | А |
| Continuous Source Current (Body Diode)(b) | I _S | -0.88 | А |
| Pulsed Source Current (Body Diode)(c) | I _{SM} | -4.3 | Α |
| Power Dissipation at T _A =25°C (a) Linear Derating Factor | P _D | 625 5 | mW mW/°C |
| Power Dissipation at T _A =25°C (b) Linear Derating Factor | P _D | 806 6.4 | mW mW/°C |
| Operating and Storage Temperature Range | T _j :T _{stg} | -55 to +150 | °C |

THERMAL RESISTANCE

| PARAMETER | SYMBOL | VALUE | UNIT |
|-------------------------|-----------------|-------|------|
| Junction to Ambient (a) | $R_{\theta JA}$ | 200 | °C/W |
| Junction to Ambient (b) | $R_{\theta JA}$ | 155 | °C/W |

NOTES:

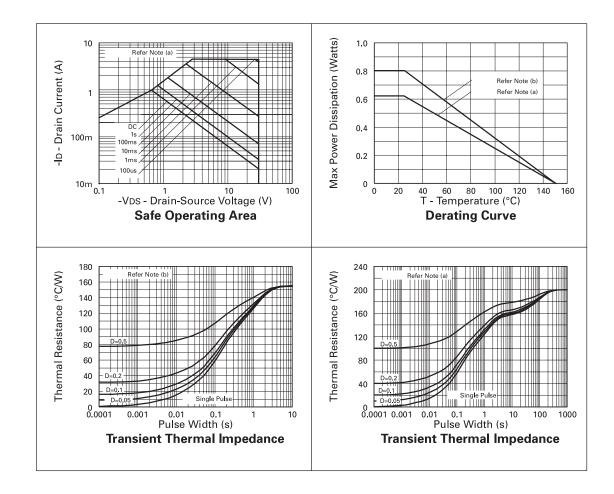
(a) For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions

(c) Repetitive rating - pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph.



⁽b) For a device surface mounted on FR4 PCB measured at t≤5 secs.

CHARACTERISTICS





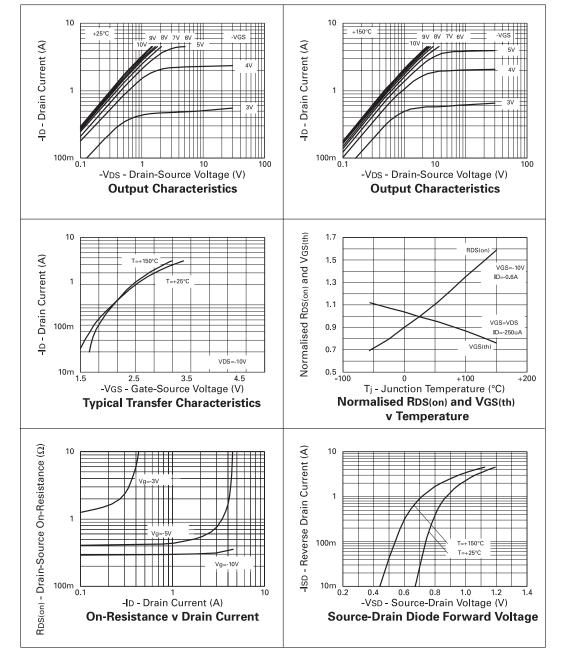
ELECTRICAL CHARACTERISTICS (at T..... = 25°C unless otherwise stated).

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT | CONDITIONS. | |
|---|----------------------|------|------|--------------|------|--|--|
| STATIC | ' | | | | | , | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | -30 | | | V | I _D =-250μA, V _{GS} =0V | |
| Zero Gate Voltage Drain Current | I _{DSS} | | | -1 | μА | V _{DS} =-30V, V _{GS} =0V | |
| Gate-Body Leakage | I _{GSS} | | | ±100 | nA | V_{GS} = $\pm 20V$, V_{DS} = $0V$ | |
| Gate-Source Threshold Voltage | V _{GS(th)} | -1.0 | | | V | I _D =-250μA, V _{DS} = V _{GS} | |
| Static Drain-Source On-State Resistance (1) | R _{DS(on)} | | | 0.35 0.55 | Ω | V _{GS} =-10V, I _D =-0.6A V _{GS} =-4.5V, I _D =-0.3A | |
| Forward Transconductance (3) | g _{fs} | 0.44 | | | S | V _{DS} =-10V,I _D =-0.3A | |
| DYNAMIC (3) | | | • | | | | |
| Input Capacitance | C _{iss} | | 140 | | pF | V _{DS} =-25 V, V _{GS} =0V, f=1MHz | |
| Output Capacitance | Coss | | 45 | | pF | | |
| Reverse Transfer Capacitance | C _{rss} | | 20 | | pF | | |
| SWITCHING(2) (3) | | | • | | • | | |
| Turn-On Delay Time | t _{d(on)} | | 1.9 | | ns | V _{DD} =-15V, I _D =-0.6A | |
| Rise Time | t _r | | 2.9 | | ns | | |
| Turn-Off Delay Time | t _{d(off)} | | 8.9 | | ns | $R_G=6.2\Omega$, $R_D=25\Omega$ (Refer to test circuit) | |
| Fall Time | t _f | | 5.0 | | ns | | |
| Total Gate Charge | Qg | | | 4.8 | nC | V _{DS} =-24V,V _{GS} =-10V, I _D =-0.6A (Refer to test circuit) | |
| Gate-Source Charge | Q _{gs} | | | 0.62 | nC | | |
| Gate Drain Charge | Q _{gd} | | | 1.3 | nC | | |
| SOURCE-DRAIN DIODE | | | • | | • | | |
| Diode Forward Voltage (1) | V _{SD} | | | -0.95 | V | T _j =25°C, I _S =-0.6A, V _{GS} =0V | |
| Reverse Recovery Time (3) | t _{rr} | | 14.8 | | ns | T _j =25°C, I _F =-0.6A, di/dt= 100A/μs | |
| Reverse Recovery Charge(3) | Q _{rr} | | 7.7 | | nC | αι/ατ= 100A/μs | |

- (1) Measured under pulsed conditions. Width=300μs. Duty cycle ≤2%.
 (2) Switching characteristics are independent of operating junction temperature.
- (3) For design aid only, not subject to production testing.



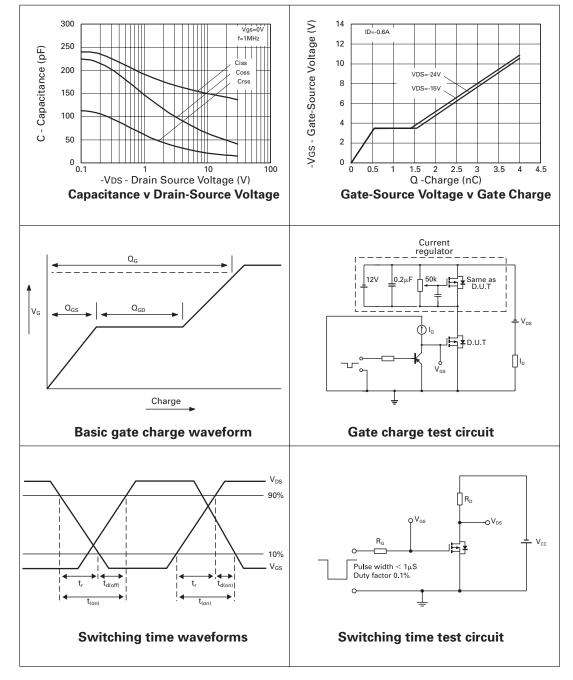
TYPICAL CHARACTERISTICS







TYPICAL CHARACTERISTICS

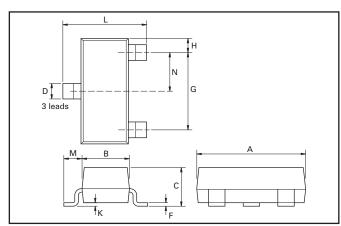


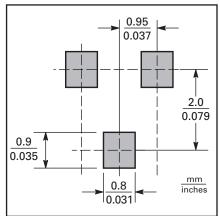
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PACKAGE DETAILS

PAD LAYOUT DETAILS





PACKAGE DIMENSIONS

| | Millin | neters | Inc | hes | Millimeters | | neters | Inches | | |
|-----|--------|--------|--------|--------|-------------|----------|--------|------------|--------|--|
| DIM | Min | Max | Min | Max | DIM | Min | Max | Max | Max | |
| Α | 2.67 | 3.05 | 0.105 | 0.120 | Н | 0.33 | 0.51 | 0.013 | 0.020 | |
| В | 1.20 | 1.40 | 0.047 | 0.055 | K | 0.01 | 0.10 | 0.0004 | 0.004 | |
| С | _ | 1.10 | _ | 0.043 | L | 2.10 | 2.50 | 0.083 | 0.0985 | |
| D | 0.37 | 0.53 | 0.015 | 0.021 | М | 0.45 | 0.64 | 0.018 | 0.025 | |
| F | 0.085 | 0.15 | 0.0034 | 0.0059 | N | 0.95 NOM | | 0.0375 NOM | | |
| G | 1.90 | NOM | 0.075 | NOM | _ | _ | | _ | _ | |

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